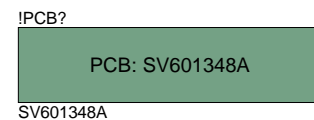
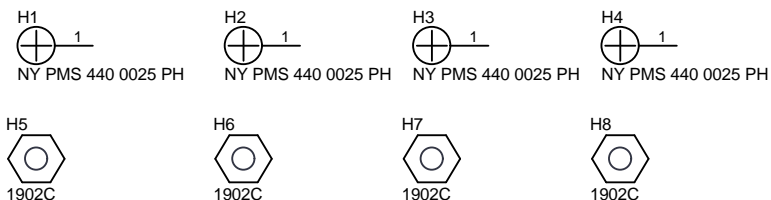


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Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 12/18/2017
TID #: PMP21278	Project Title: Change in menu Project/Parameter	
Number: PMP21278	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: PMP21278_REVA.SchDoc	Size: B
Engineer: Xinyu Dai	Contact: http://www.ti.com/support	



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Variant/Label Table	
Variant	Label Text
001	

ZZ1
Label Assembly Note
 This Assembly Note is for PCB labels only

ZZ2
Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 11/20/2017
TID #: PMP21278	Project Title: Change in menu Project\Project Options\Parameters	
Number: PMP21278	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2
Drawn By:	File: SV601348_REVA_Hardware.SchDoc	Size: B
Engineer: Xinyu Dai	Contact: http://www.ti.com/support	

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